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Organic Foam Thermal Insulation Materials

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Highlights

- THS method has good measurement accuracy for foam thermal insulation materials.
- Appropriate heating power for foam thermal insulation materials was proposed.
- Appropriate test temperature rise for foam thermal insulation materials is 6°C.
- The repeatability accuracy of THS method is better than THW method.

Abstract

Using low thermal conductivity building insulation materials is an effective way to reduce heat transfer through walls in a building therefore save building energy cost. A device based on the transient hot strip (THS) method was developed to measure thermal conductivities of organic foam thermal insulation materials. The influences of sample dimension and heating power on the calculation accuracy of the thermal conductivity were analyzed by numerical simulations and compared with experimental results. Moreover, the selection method of the appropriate heating power was proposed. The measurement results show that the device has good accuracy for measuring organic foam insulation materials and outperforms transient hot wire (THW) method. **Key words**: transient hot-strip method, organic foam thermal insulation material, thermal

conductivity, numerical simulation, measurement accuracy

Nomenclature				
c _p erfc	Specific heat capacity (J/kg K) Complementary error function	З	Relative error of thermal conductivity	
h	Convective heat transfer coefficient $(W/m^2 K)$	λ	Thermal conductivity (W/m K)	
H	Sample height (mm)	1	Standard value of thermal	
Κ	Correction coefficient	λ_0	conductivity (W/m K)	
L	Sample length (mm)	ρ	Density (kg/m ³)	
P_0	Heating power per unit length (W/m)	τ	Dimensionless time	
q	Heat flux density (W/m^2)			
R^2	Linear fitting degree	Subscripts		
t	Time (s)	1	Scale division of $0.00001^\circ\mathbb{C}$	
Т	Average temperature of the strip ($^{\circ}C$)	2	Scale division of 0.1° C	
T_0	Initial temperature of the strip ($^{\circ}C$)	ex	Experimental value	
ΔT	Temperature rise of the strip ($^{\circ}$ C)	hw	Transient hot-wire method	
W	Sample width (mm)	id	Theoretical value	
Ws	Half width of the strip (mm)	m	Sample	
		max	Maximum value	
Greek symbols		min	Minimum value	
α	Thermal diffusivity (m^2/s)	S	Hot strip	
γ	Euler constant, =0.5772			

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